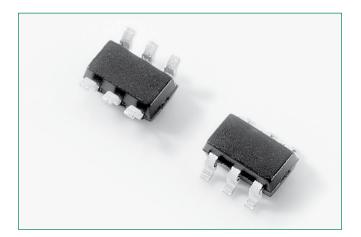
## SP3025 Series

### **Lightning Surge Protection**

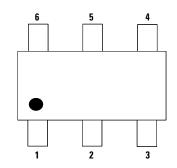




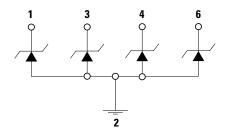


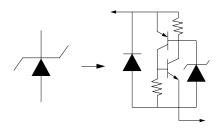


### **Pinout**



### **Functional Block Diagram**





### **Description**

The SP3025 is a low-capacitance, TVS Diode Array designed to provide protection against ESD (electrostatic discharge), CDE (cable discharge events), EFT (electrical fast transients), and lightning induced surges for highspeed, differential data lines. It's packaged in a SOT23-6L and each device can protect up 4 channels up to 30A (IEC 61000-4-5 2nd edition,) and up to ±30kV ESD (IEC 61000-4-2).

The SP3025 with its low capacitance and low clamping voltage makes it ideal for high-speed data interfaces such as 1GbE applications found in notebooks, switches, etc.

### **Features & Benefits**

- ESD, IEC 61000-4-2, ±30kV contact, ±30kV air
- EFT, IEC 61000-4-4, 40A (5/50ns)
- Lightning, IEC 61000- 4-5 2nd edition, 30A (tP=8/20µs)
- Low capacitance of 1.7pF@0V
- Low leakage current of 1nA (TYP) at 2.5V
- Low operating and clamping voltage
- Provides protection for two differential data pairs (4 channels) up to 30A
- Halogen free, Lead free and RoHS compliant
- Moisture Sensitivity Level (MSL -1)

### **Applications**

1

- 10/100/1000 Ethernet
- WAN/LAN Equipment
- Desktops, Servers and Notebooks
- LVDS Interfaces
- Integrated Magnetics
- Smart TV
- 2.5G/5G/10G Ethernet

### Life Support Note:

Not Intended for Use in Life Support or Life Saving Applications

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.



### **Absolute Maximum Ratings**

Symbol	Parameter	Value	Units
I <sub>PP</sub>	Peak Current (t <sub>p</sub> =8/20µs)	30	А
$T_{oP}$	Operating Temperature	-40 to 125	°C
$T_{stor}$	Storage Temperature	-55 to 150	°C

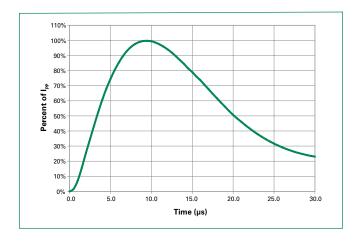
Caution: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the component. This is a stress only rating and operation of the component at these or any other conditions above those indicated in the operational sections of this specification is not implied.

### **Electrical Characteristics** (T<sub>OP</sub>=25°C)

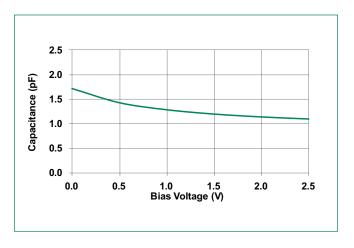
Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Reverse Standoff Voltage	$V_{RWM}$	$I_R = 1\mu A$			2.5	V
Breakdown Voltage	$V_{BR}$	$I_{R} = 1mA$	5.5	7.0		V
Reverse Leakage Current	I <sub>LEAK</sub>	V <sub>R</sub> =2.5V		1	100	nA
Holding Voltage	$V_{HOLD}$	I/O to GND		1.6		V
Clamp Voltage <sup>1</sup>	V <sub>c</sub>	$I_{pp} = 30A, t_{p} = 8/20 \mu s$		9	11	V
Dynamic Resistance <sup>2</sup>	R <sub>DYN</sub>	TLP, t <sub>p</sub> =100ns		0.14		Ω
ESD Withstand Voltage <sup>1,3</sup>	V <sub>ESD</sub>	IEC 61000-4-2 (Contact Discharge)	±30			kV
		IEC 61000-4-2 (Air Discharge)	±30			kV
Diode Capacitance <sup>1</sup>	C <sub>I/O-GND</sub>	Reverse Bias=0V, f=1MHz		1.7	2.5	pF
	C <sub>I/O-I/O</sub>			0.8	1.2	

- 1. Parameter is guaranteed by design and/or component characterization.
  2. Transmission Line Pulse (TLP) test setting: Std.TDR(50Ω),tp=100ns, tr=0.2ns ITLP and VTLP averaging window: start t1=70ns to end t2=90ns
  3. Device stressed with ten non-repetitive ESD pulses.

### 8/20µs Pulse Waveform



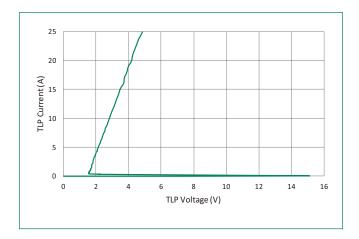
### Capacitance vs. Reverse Bias



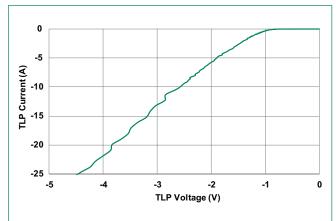


# **SP3025 Series**Lightning Surge Protection

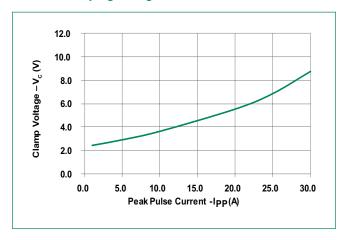
### Positive Transmission Line Pulsing (TLP) Plot



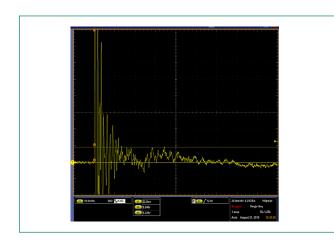
### **Negative Transmission Line Pulsing (TLP) Plot**



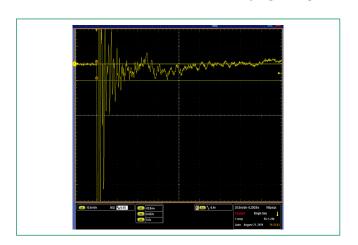
### Clamping Voltage vs. Peak Pulse Current



IEC 61000-4-2 +8kV Contact ESD Clamping Voltage



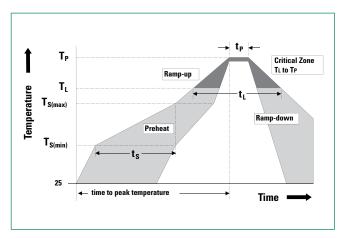
IEC 61000-4-2 -8kV Contact ESD Clamping Voltage





### **Soldering Parameters**

Reflow Condition Pb – Free assemble			
Pre Heat	-Temperature Min (T <sub>s(min)</sub> )	150°C	
	-Temperature Max (T <sub>s(max)</sub> )	200°C	
	-Time (min to max) (t <sub>s</sub> )	60 – 120 secs	
Average ramp up rate (Liquidus) Temp (T <sub>L</sub> ) to peak		3°C/second max	
T <sub>S(max)</sub> to T <sub>L</sub> - Ramp-up Rate		3°C/second max	
Reflow	-Temperature (T <sub>L</sub> ) (Liquidus)	217°C	
	-Temperature (t <sub>L</sub> )	60 - 150 seconds	
Peak Temperature (T <sub>P</sub> )		260+0/-5 °C	
Time within	5°C of actual peak Temperature (t <sub>p</sub> )	30 seconds	
Ramp-down Rate		6°C/second max	
Time 25°C to peak Temperature (T <sub>p</sub> )		8 minutes Max.	
Do not exceed		260°C	



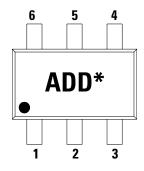
### **Ordering Information**

Part Number	Package	Min. Order Qty.
SP3025-04HTG	SOT23-6L	3000

### **Product Characteristics**

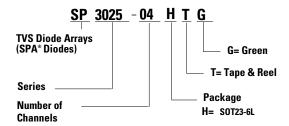
Lead Plating	Matte Tin
Lead Material	Copper Alloy
Lead Coplanarity	0.004 inches (0.102mm)
Substrate Material	Silicon
Body Material	Molded Compound
Flammability	UL Recognized compound meeting flammability rating V-0

### **Part Marking System**



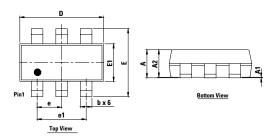
AD : Part code D : Assembly code \* : Date code

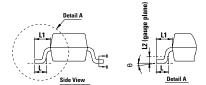
### **Part Numbering System**



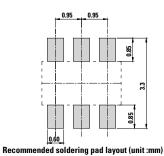


### Package Dimensions — SOT23-6L





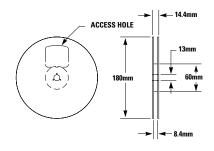


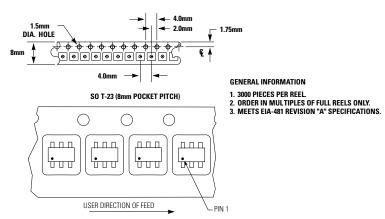


Millimeters Symbol Min Nom Max Α 1.45 Α1 0.00 0.15 A2 0.90 1.15 1.30 b 0.30 0.50 b1 0.30 0.40 0.45 0.08 0.22 С с1 0.08 0.13 0.20 D 2.75 2.90 3.05 Ε 2.60 2.80 3.00 E1 1.45 1.60 1.75 0.95 BSC е 1.90 BSC e1 L 0.60 0.30 0.50 L1 0.60 REF L2 0.25 BSC θ 0° 4° 8°

### Embossed Carrier Tape & Reel Specification — SOT23-6L

### 8mm TAPE AND REEL





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